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Additional name(s) of conveying party(ies) attached? No	Address: 6-10, Koishikawa 4-chome, Bunkyo-ku, Tokyo, 112-		
3. Nature of conveyance:	8088, Japan		
X Assignment Merger Security Agreement Change of Name Other Execution Date: July 19, 2006	Additional name(s) & address(es) attached? No		
4. Application number(s) or patent number(s):			
If this document is being filed together with a new application, the exe A. Patent Application No.(s) NEW, filed October 27, 2006 Additional number	B. Patent No.(s) 11/579063		
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1		
Name: <u>WENDEROTH, LIND &amp; PONACK, L.L.P.</u> <u>Attn: Warren M. Cheek, Jr., Esq.</u>	7. Total fee (37 CFR 3.41)\$\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		
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ATTACHMENT C

**REEL: 018494 FRAME: 0693** 

## ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s) of Inventor(s)

(1)Chikako HAKII

(2)Mitsugu USUI

the undersigned hereby sell(s) and assign(s) to

Insert Name(s) of Assignee(s)

EISAI R&D MANAGEMENT CO., LTD.

of 6-10, Koishikawa 4-chome, Bunkyo-ku, Tokyo, 112-8088, Japan

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of Invention

Address

HYBRIDIZATION METHOD

for which an application for patent in the United States has been executed by the undersigned

Date of Signing of Application

on (1) July 19, 2006 (2) July 19, 2006

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

PATENT REEL: 018494 FRAME: 0694

In witness whereof, execuname(s).	ted by the unders	signed on the da	ate(s) opposite	e the undersigned	
Date <u>July 19, 2006</u>	, Name of the I	nventor	hipapo	Hapii	
Date <u>July 19, 2006</u> Date <u>July 19, 2006</u>	, Name of the I	nventor	ritsuga	Claui	_
Date					
Date	, Name of the I	nventor			_
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Date	, Name of the I	nventor	<u> </u>		_
witness Witness Witness	mitsu Do uhilm Tu ACKNOWL	Toxes.		_	
This	d me personally k knowledge to me	known as the in	dividual(s) wł	no executed the	wn
SEAL			Official Sign	ature	
			Official Title		
The above application ma	y be more particu	ılarly identified	as follows:		
U.S. Application Serial No		Filing Da	ate		
Applicant Reference Number	<u> </u>	Atty Do	cket No		
Title of Invention					

2

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**RECORDED: 10/27/2006**